



EU Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that this DoC is issued under our sole responsibility and belongs to the following product(s):

Product Type:	Evaluation Kit
Model Name:	
Model Number:	BOOSTXL-ULPSENSE EVM

The object of the declaration described above is in conformity with the following relevant Union harmonization legislation:

- Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS)

Technical Compliance Data held by:

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

Name:	Mark Frimann
Address:	13121 TI Blvd. Dallas, TX 75243

Dallas, TX, USA

Place of issue

26 July 2018

Date of issue

Signature of Authorized Person



EU Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

Product Type:	Launchpad Kit / Evaluation Board
Model Number(s):	BOOSTXL-ULPSENSE
Trademark:	Texas Instruments Incorporated

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

Electromagnetic Compatibility Directive 2014/30/EU

The following harmonized standards and technical specifications have been applied:

Art 3.1b: EN 61326-1:2013

Notified Body:

Notified Body:	Nemko AS
Notified Body Number	0470
Reference number of the certificate of notified body	0470-EMC-183201

Technical Compliance File Held by:

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

Name:	Dag Grini, Business CQE, EPD/CONN MCU/LPRF
Address:	Hoffsveien 70C, N-0377 Oslo, Norway

Oslo 2018-08-17 Dag Grini
Place of issue Date of issue Signature of Authorized Person

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